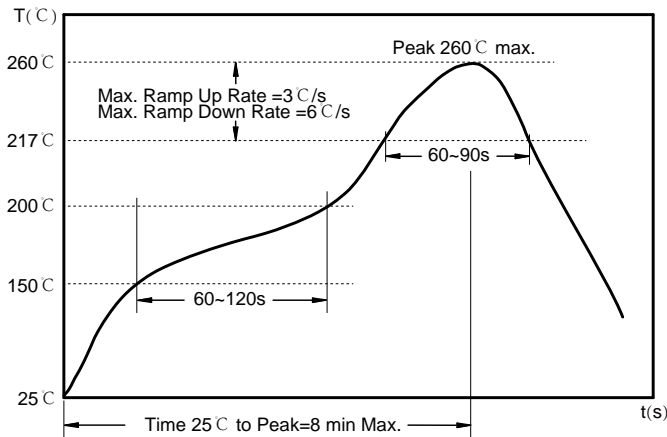






## Soldering Reflow:



Preheat condition: 150 ~200 °C / 60~120 sec.

Allowed time above 217 °C : 60~90 sec.

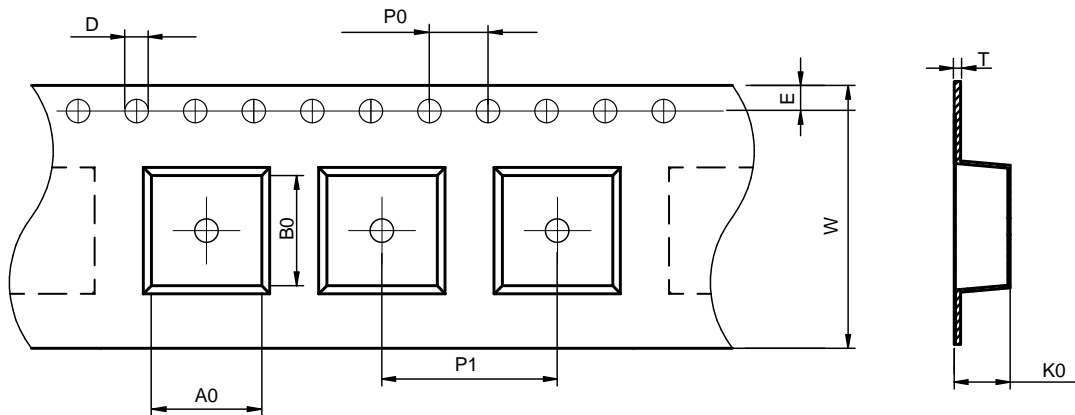
Max temperature: 260 °C .

Max time at max temperature: 10 sec.

Allowed Reflow time: 2x max.

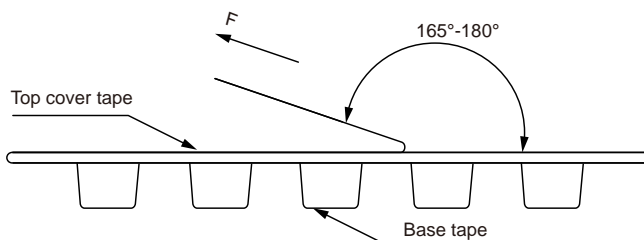
## Packaging Information:

### Tape Dimension :



Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
MDTA6060	7.0± 0.1	6.8± 0.1	1.5± 0.1	4.0± 0.1	12.0± 0.1	16.0± 0.3	6.3± 0.1	1.75± 0.1	0.50± 0.05

### Peel force of top cover tape:



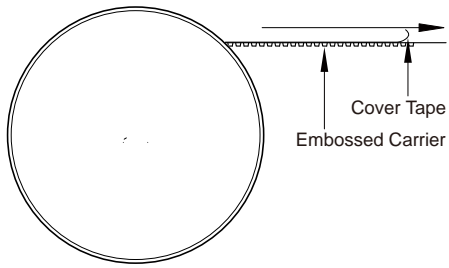
The peel force of top cover tape shall be between 0.1 to 1.3 N

### Product Marking:

Marking	Printing Inductance)
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Reel Dimension: [mm]



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Packaging Quantity: